

SEP 12 2005

## Certificate of Facsimile Transmission

I hereby certify that the attached Transmittal (1 page), Response to the Office Action dated June 14, 2005 (7 pages), PTO form 2038 authorizing credit card payment of \$200.00 for additional claim fee are submitted to the U.S. Patent and Trademark Office via facsimile number 571-273-8300 on the date shown below. (Total 9 pages).

  
 Li Mei Vermilya

Date: September 12, 2005

 PATENT APPLICATION  
 Attorney Docket No. 9903-071  
 Client Ref. No. S02US035

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Jin-Hyuk LEE, et al.

Serial No.: 10/690,782

Examiner: Graybill, David E.

Filed: October 21, 2003

Group Art Unit: 2822

Confirmation No.: 5611

 For: METHOD FOR MANUFACTURING A WAFER LEVEL CHIP  
 SCALE PACKAGE

 MAIL STOP AMENDMENT  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Responsive to the Final Office Action dated June 14, 2005, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

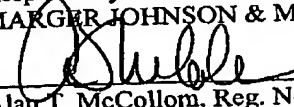
CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	19	17	0	x \$50 =	\$0
Independent Claims	4	3	1	x \$200 =	\$200
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$200

\*greater of twenty (20) or number for which fee has been paid  
 \*\*greater of three (3) or number for which fee has been paid

- ☒ PTO Form 2038 authorizing credit card payment for the above-listed fees is enclosed.  
☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

 Respectfully submitted,  
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Commissioner for Patents  
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## AMENDMENT

Responsive to the Office Action, Paper No. 20050608, dated June 14, 2005, please  
amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on  
page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.

09/13/2005 MBINAS 00000035 10690782  
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